

## PRODUCT / PROCESS CHANGE NOTIFICATION PCN-000825

**Date: JUN-03-2022** P1/2

Semtech Corporation, 200 Flynn Road, Camarillo CA 93012						
Change Details						
Part Number(s) Affected:		Customer Part Number(s) Affected: ⊠ N/A				
GN3357-3EB9AQ9E3						
Description, Purpose and Effect of Change:						
Semtech's supplier of ROSA's flex cable F10028 is changing the coverlay film material:						
Coverlay film materia	l Ne	W	Old	1		
Part number	FHK0					
Manufacturer	TAIFLEX Scien					
	., til EE/t Jeici		drace Electron corp			
Change Classification	☐ Major ⊠ Mino		o Form, Fit,	☐ Yes	⊠ No	
Impact to Data Sheet	☐ Yes 🖂 No	_	ision or Date		⊠ N/A	
Impact to Performance, Characteristics or Reliability:						
The change mentioned above have no impact on performance, characteristics, or reliability. There is no impact to form, fit, or function. Qualification of FHK0525 coverlay for F10028 is bridged to qualification of similar flex cables F10034 and F10012, used in production since 2014.						
Implementation Date	JUL-03-2022	Wor	k Week	28	8	
Last Time Ship (LTS) Of unchanged product	N/A		g Lot No. / No. (SN)	N/A		
Sample Availability	Available Upon Requ	est Ava	ation Report ilability	Available Upon Request		
Supporting Documents for Change Validation/Attachments:						
Please see the following pages.						



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Issuing Authority						
Semtech Business Unit:	Signal Integrity Product Group (SIP)					
Semtech Contact Info:	Pedro Jr. Bernas pbernas@semtech.com (289) 856-9326 x1162					
FOR FURTHER INFORMATION & WORLDWIDE SALES COVERAGE: http://www.semtech.com/contact/index.html#support						

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## Comparison between new and old cover lay materials:

Items	New coverlay material	Old coverlay material	
Supplier	TAIFLEX Scientific Co. Ltd	Grace Electron Corp	
Part Number	FHK0525	CNV025XMK1	
PI film thickness	12.5um	12.5um	
Adhesive thickness	25um	25um	
Halogen free	Yes	Yes	
Solder float resistance	300°C/10sec	300°C/10sec	
Peel strength	≧0.5kgf/cm	≧0.6kgf/cm	

- Data sheets of new and old cover lay materials available upon request
- Drawing of F10028 flex available upon request
- Qualification Reports available upon request